

STG6684

High isolation dual SPDT analog switch

Features

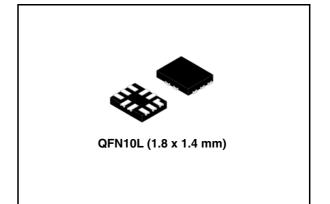
- Ultra high off-isolation:
 -80 dB (typ) at 1 Mhz
- Ultra low power dissipation:
 I_{CC} = 0.2 μA (max.) at T_A = 85 °C
- R_{PEAK} on $T_n = 1.30 \Omega$ max ($T_A = 25 °C$) at $V_{CC} = 4.3 V$
- R_{PEAK} on $S_n = 0.55 \Omega$ max ($T_A = 25 °C$) at $V_{CC} = 4.3 V$
- Wide operating voltage range:
 V_{CC} (opr) = 1.65 to 4.3 V single supply
- 4.3 V tolerant and 1.8 V compatible threshold on digital control input at V_{CC} = 1.65 to 4.3 V
- Typical bandwidth (-3 dB) at 65 MHz on Sn channel, 58 MHz on the T_n channel
- Latch-up performance exceeds 100 mA per JESD 78, Class II
- ESD performance exceeds JESD22 2000-V Human body model (A114-A)

Description

The STG6684 is a high-speed CMOS low voltage dual analog SPDT (single pole dual throw) switch or 2:1 multiplexer/de-multiplexer switch fabricated in silicon gate C²MOS technology.

The STG6684 is designed to operate from 1.65 to 4.3 V, making this device ideal for portable applications.

The SELn inputs are provided to control the switch operation. The switch Sn is ON (connected to common ports Dn) when the SELn input is held low and OFF (high impedance state exists between the two ports) when SELn is held high.



The switch Tn is "on" (connected to common port Dn) when the SELn input is held high and "off" (high impedance state exists between the two ports) when SELn is held low.

Additional key features are fast switching speed, break-before-make delay time and ultra low power consumption. All inputs and outputs are equipped with protection circuits against static discharge, giving them ESD immunity and transient excess voltage.

Table 1.Device summary

Order code	Package	Packaging
STG6684QTR	QFN10L (1.8 x 1.4 mm)	Tape and reel

January 2008

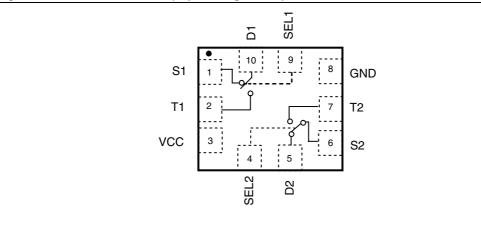
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1 Pin settings

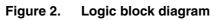
Figure 1.	Pin connection	(top through view)
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Pin number	Symbol	Name and function
1	S1	Independent channel
2	T1	Independent channel
3	V _{CC}	Positive supply voltage
4	SEL2	Selection control
5	D2	Common channel
6	S2	Independent channel
7	T2	Independent channel
8	GND	Ground (0 V)
9	SEL1	Selection control
10	D1	Common channel



2 Logic diagram



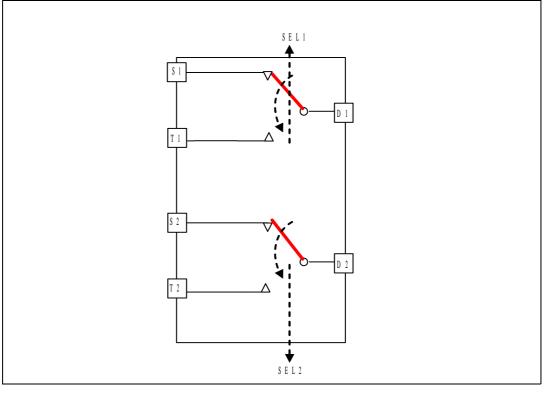


Table 3. Truth table

SELn	Switch Sn	Switch Tn
L	Sn is connected to Dn	OFF ⁽¹⁾
Н	OFF ⁽¹⁾	Tn is connected to Dn

1. High impedance



3 Maximum rating

Stressing the device above the rating listed in the "Absolute maximum ratings" table may cause permanent damage to the device. These are stress ratings only and operation of the device at these or any other conditions above those indicated in the operating sections of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability. Refer also to the STMicroelectronics SURE Program and other relevant quality documents.

Symbol	Parameter	Value	Unit
V _{CC}	Supply voltage	-0.5 to 5.5	V
VI	DC input voltage	-0.5 to V _{CC} + 0.5	V
V _{IC}	DC control input voltage	-0.5 to 5.5	V
V _O	DC output voltage	-0.5 to V _{CC} + 0.5	V
I _{IKC}	DC input diode current on control pin (V _{SEL} < 0 V)	-50	mA
I _{IK}	DC input diode current (V _{SEL} < 0 V)	±50	mA
I _{ОК}	DC output diode current	±20	mA
۱ ₀	DC output current	±300	mA
I _{OP}	DC output current peak (pulse at 1 ms, 10% duty cycle)	±500	mA
I _{CC} or I _{GND}	DC V _{CC} or ground current	±100	mA
P _D	Power dissipation at $T_A=70 \ ^{\circ}C^{(1)}$	1120	mW
T _{STG}	Storage temperature	-65 to 150	°C
TL	Lead temperature (10 sec)	300	°C

Table 4. Absolute maximum ratings

1. Derate above 70 °C by 18.5 mW/°C



3.1 Recommended operating conditions

Table 5.	Recommended	operating	conditions
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Symbol	Parameter	Value	Unit	
V _{CC}	Supply voltage		1.65 to 4.3	V
VI	Input voltage		0 to V _{CC}	V
V _{IC}	Control input voltage	0 to 4.3	V	
Vo	Output voltage	0 to V _{CC}	V	
T _{op}	Operating temperature		-40 to 85	°C
dt/dv	Input rise and fall time control	V _{CC} = 1.65 V to 2.7 V	0 to 20	200
uvuv	input	V _{CC} = 3.0 V to 4.3 V	0 to 10	ns/V



4 Electrical characteristics

				Value					
Symbol	Parameter	V _{CC} (V)	Test condition	Tے	(= 25 °	°C	-40 to	85 °C	Unit
		(•)		Min	Тур	Max	Min	Max	
		1.65 –1.95		0.65			0.65		
				V _{CC}			V _{CC}		
V _{IH}	High level input	2.3 –2.5		1.2			1.2		v
	voltage	2.7 –3.0		1.3			1.3		
	3.3 –3.6		1.4			1.4			
		4.3		1.5			1.5		
		1.65 –1.95				0.25		0.25	
	Low level input	2.3 –2.5				0.25		0.25	
V_{IL}	voltage	2.7 –3.0				0.25		0.25	V
	3.3 –3.6				0.30		0.30		
		4.3				0.40		0.40	
/	Switch T _n ON resistance	4.3	V _S = 0 V to V _{CC} I _S = 100 mA		1.10	1.3		1.5	Ω
		3.6			1.15	1.4		1.6	
		3.0			1.25	1.5		1.8	
		2.7			1.35	1.6		1.9	
		1.8			2.20	2.9		3.5	
		4.3			0.45	0.55		0.62	Ω
Б	Switch S _n ON	3.6	$V_{S} = 0 V \text{ to } V_{CC}$		0.48	0.58		0.65	
R _{PEAK,} Sn	resistance	3.0	$I_{\rm S} = 100 \text{mA}$		0.51	0.62		0.70	
		2.7			0.54	0.70		0.80	
		1.8			0.84	1.10		1.30	
		4.3			10				
	ON resistance	3.6	V- at R		14				
$\Delta R_{ON,}$ Tn	match between	3.0	V _S at R _{PEAK} I _S = 100 mA		14				mΩ
	Tn channels ⁽¹⁾	2.7			15				
		1.8			30				
		4.3			7				
	ON resistance	3.6	V. at P		7				mΩ
∆R _{ON,} Sn	match between	3.0	V _S at R _{PEAK} I _S = 100 mA		8				
	Sn channels ⁽¹⁾	2.7	Ŭ		9				
		1.8			12				

Table 6. DC specifications



				Value					
Symbol	Parameter	V _{CC} (V)	Test condition	Test condition T _A = 25 °C		°C	C -40 to 85		°C Unit
		(•)		Min	Тур	Max	Min	Max	
		4.3			0.45	0.50		0.55	
	ON resistance	3.6			0.45	0.50		0.55	
R _{FLAT,} Tn	flatness for Tn	3.0	$V_S = 0$ to V_{CC} $I_S = 100$ mA		0.50	0.55		0.60	Ω
	channels ⁽²⁾	2.7			0.55	0.60		0.70	
		1.8			1.10	1.70		2.00	
	ON resistance	4.3	$V_{S} = 0$ to V_{CC} $I_{S} = 100$ mA		0.15	0.20		0.20	
R _{FLAT,} channels ⁽²⁾	flatness for Sn	3.6			0.15	0.20		0.20	
	R _{FLAT,} Sn	3.0			0.15	0.20		0.20	Ω
0.11		2.7			0.15	0.20		0.20	
		1.8			0.35	0.55		0.66	
I _{OFF}	OFF state leakage current (Tn), (Sn), (Dn)	4.3	V _S = 0.3 or 4 V			±0.1		±1	μA
I _{SEL}	SEL leakage current	0 –4.3	V _{SEL} = 0 to 4.3 V			±0.05		±1	μA
I _{CC}	Quiescent supply current	1.65 –4.3	V _{SEL} = V _{CC} or GND			±0.05		±0.2	μA
	Quiescent		V _{SEL} = 1.65 V		±37	±50		±100	
I _{CCLV}	supply current low voltage	4.3	V _{SEL} = 1.80 V		±33	±40		±50	μA
	driving		V _{SEL} = 2.60 V		±12	±20		±30	

Table 6. DC specifications

1. $\Delta R_{ON} = R_{ON(max)} - R_{ON(min)}$.

2. Flatness is defined as the difference between the maximum and minimum value of on-resistance as measured over the specified analog signal ranges.

				Value					
Symbol	Parameter	V _{CC} (V)	Test condition	T _A = 25 °C			-40 to	Unit	
		(-)		Min	Тур	Max	Min	Max	
		1.65 —1.95			0.45				
t _{PLH,}	Propagation	2.3 —2.7			0.45				
t _{PHL} delay	3.0 —3.3			0.30				ns	
		3.6 -4.3			0.30				
	1.65 —1.95	V _S = 0.8 V		120					
	TONE	2.3 —2.7			65	85		90	
t _{ON} Turn-ON time	3.0 -3.3	V _S = 1.5 V		42	55		65	ns	
		3.6 -4.3			40	55		65	-
		1.65 —1.95	V _S = 0.8 V		45				
	Turn-OFF	2.3 —2.7			18	30		40	
t _{OFF}	time	3.0 -3.3	V _S = 1.5 V		16	30		40	- ns
		3.6 -4.3			15	30		40	
		1.65 —1.95		2	18				
	Break-before-	2.3 - 2.7	$C_L = 35 pF$	2	10				
t _D	make time delay	3.0 -3.3	R _L = 50 Ω V _S = 1.5 V	2	8				- ns
		3.6 -4.3		2	6				
		1.65 —1.95			43				pC
•	Charge	2.3 -2.7	C _L = 100 pF R _I = 1 MΩ		51				
Q	injection	3.0 -3.3	$V_{GEN} = 0 V$ $R_{GEN} = 0 \Omega$		51				
		3.6 -4.3	''GEN - 0 22		49				

Table 7. AC electrical characteristics ($C_L = 35 \text{ pF}, R_L = 50 \Omega, t_r = t_f \le 5 \text{ ns}$)



	Parameter	V _{CC} (V)	Test condition	Value					
Symbol				T _A = 25 °C		-40 to 85 °C		Unit	
		(*)		Min	Тур	Max	Min	Max	
OIRR _{Tn}	Off isolation for switch T1,T2	1.65 —4.3	V_{S} =1 V _{RMS} , f=1 MHz, R _L = 50 Ω		-80				dB
			V_{S} =1 V _{RMS} , f = 10 MHz, R _L = 50 Ω		-60				
OIRR _{Sn}	Off isolation for switch S1, S2	1.65 —4.3	$V_S = 1 V_{RMS},$ f = 100 kHz RL = 50 Ω		-66				dB
			V_{S} =1 V _{RMS} , f = 1 MHz R _L = 50 Ω		-45				
Xtalk _{Sn}	Crosstalk between S1 and S2	1.65 — 4.3	V_{S} =1 V_{RMS} , f = 1 MHz Signal = 0 dBm		-90				dB
			$V_S=1 V_{RMS},$ f = 10 MHz Signal = 0 dBm		-69				dB
XtalkTn	Crosstalk between T1 and T2	1.65 — 4.3	$V_S=1 V_{RMS},$ f = 1 MHz Signal = 0 dBm		-85				- dB
			V_{S} =1 V_{RMS} , f = 10 MHz Signal = 0 dBm		-74				
THD _{Sn}	Total harmonic distortion	2.3 — 4.3	f = 20 Hz to 20 kHz $R_L = 600 \Omega$ $C_L = 50 \text{ pF}$ $V_{IN} = 2 V_{P-P}$ $V_{DC} = V_{CC}/2$		0.01				%
BW _{Tn}	-3dB bandwidth for switch T1, T2	1.65 — 4.3	$R_L = 50 \Omega$ Signal = 0 dBm		58				MHz
BW _{Sn}	-3dB bandwidth for switch S1,S2	1.65 — 4.3	$R_L = 50 \Omega$ Signal = 0 dBm		65				MHz

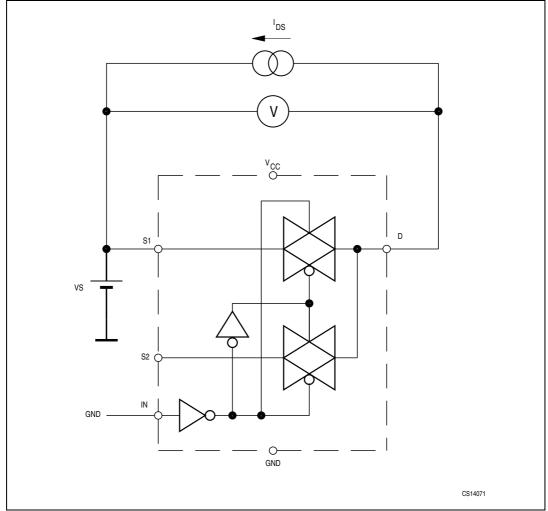
Table 8.Analog switch characteristics ($C_L = 5 \text{ pF}, R_L = 50 \Omega, T_A = 25 ^{\circ}C$)



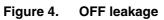
	Parameter	V _{CC} (V)	Test condition	Value					
Symbol				T _A = 25 °C			-40 to 85 °C		Unit
				Min	Тур	Max	Min	Max	
C _{SEL}	Control pin input capacitance		V _{CC} = 0 V		9				
C _{ON,Tn}	Tn port capacitance when the switch is enabled	3.3	f = 1 MHz		113				
C _{ON,Sn}	Sn port capacitance when the switch is enabled	3.3	f = 1 MHz		88				pF
C _{OFF,Tn}	Tn port capacitance when the switch is disabled	3.3	f = 1 MHz		85				
C _{OFF,Sn}	Sn port capacitance when the switch is disabled	3.3	f = 1 MHz		40				

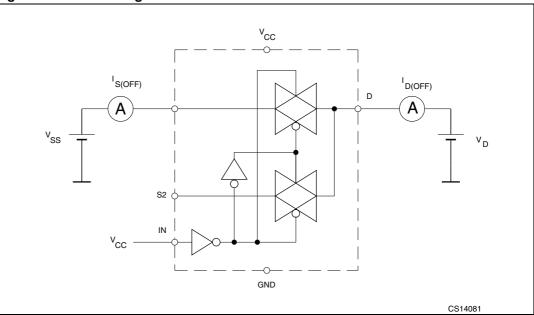
5 Test circuit



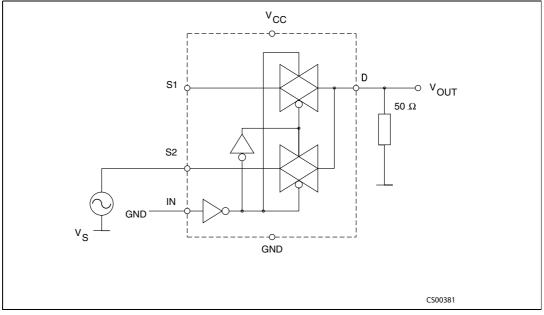














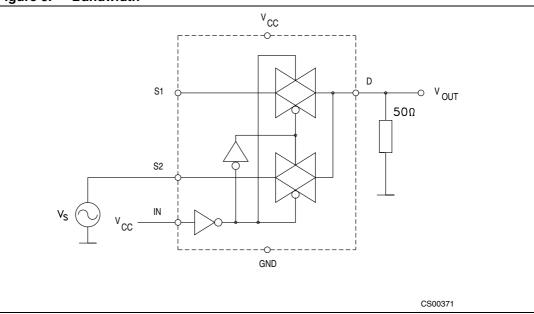
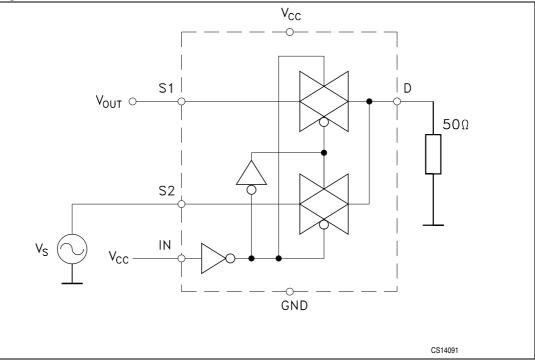
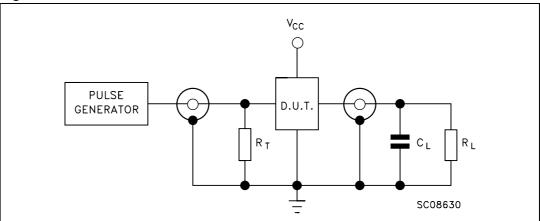


Figure 7. Switch-to-switch crosstalk



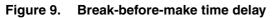


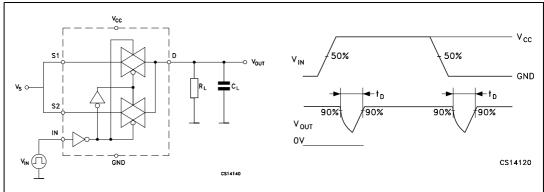


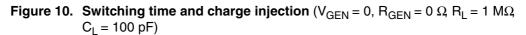
1. $C_L = 5/35 \text{ pF}$ or equivalent (includes jig and probe capacitance)

- 2. $R_L = 50 \Omega \text{ or equivalent}$
- 3. $R_T = Z_{OUT}$ of pulse generator (typically 50 Ω)









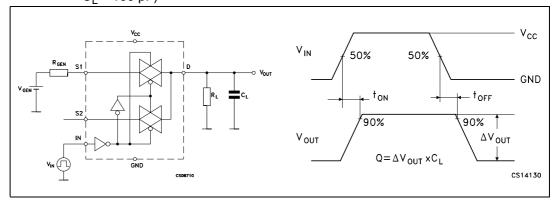
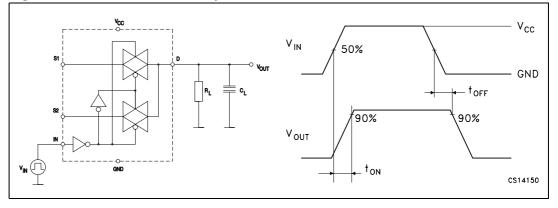


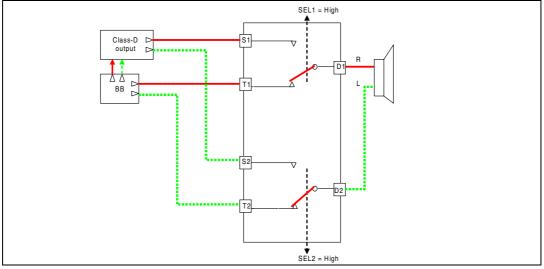
Figure 11. Turn on, turn off delay time



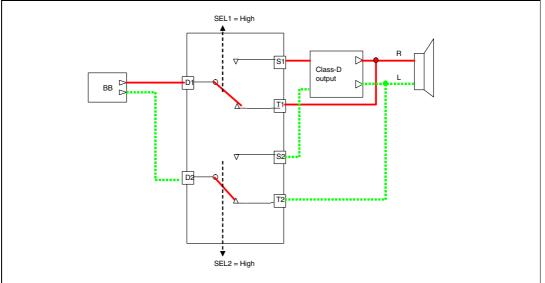
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6 Application diagram









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7 Package mechanical data

In order to meet environmental requirements, ST offers these devices in ECOPACK[®] packages. These packages have a Lead-free second level interconnect. The category of second level interconnect is marked on the package and on the inner box label, in compliance with JEDEC Standard JESD97. The maximum ratings related to soldering conditions are also marked on the inner box label. ECOPACK is an ST trademark. ECOPACK specifications are available at: www.st.com.

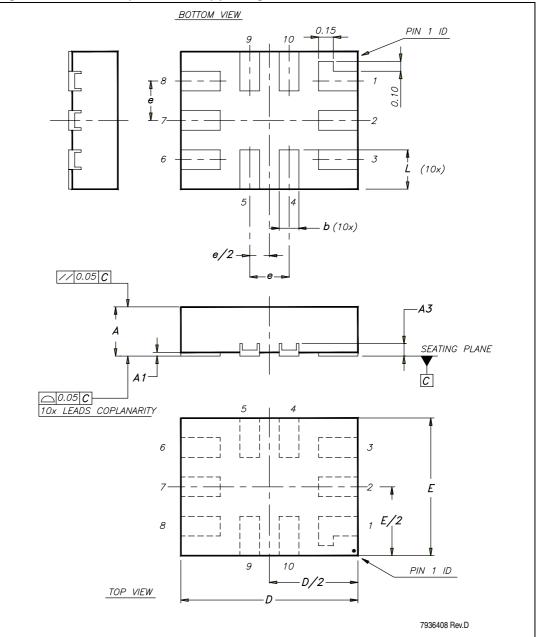


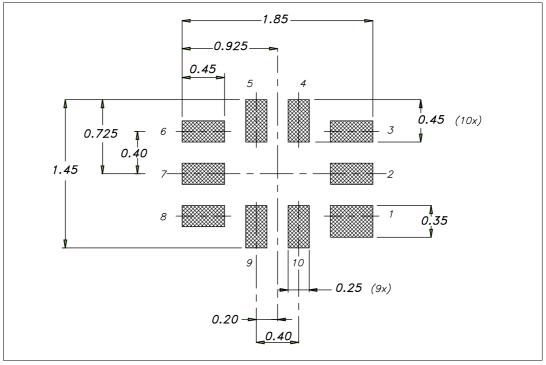
Figure 14. QFN10L (1.8 x 1.4 mm) package outline



Symbol	Millimeters						
Symbol	Min	Тур	Max				
A	0.45	0.50	0.55				
A1	0	0.02	0.05				
A3		0.127					
b	0.15	0.20	0.25				
D	1.75	1.80	1.85				
E	1.35	1.40	1.45				
e		0.40					
L	0.35	0.40	0.45				

Table 2. QFN10L(1.8 x 1.4 mm) mechanical data

Figure 15. QFN10L (1.8 x 1.4 mm) footprint recommendations



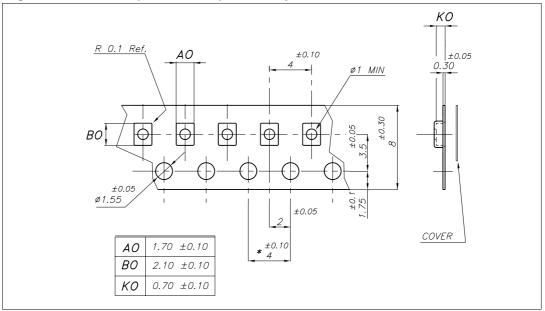


Figure 16. QFN10L (1.8 x 1.4 mm) carrier tape



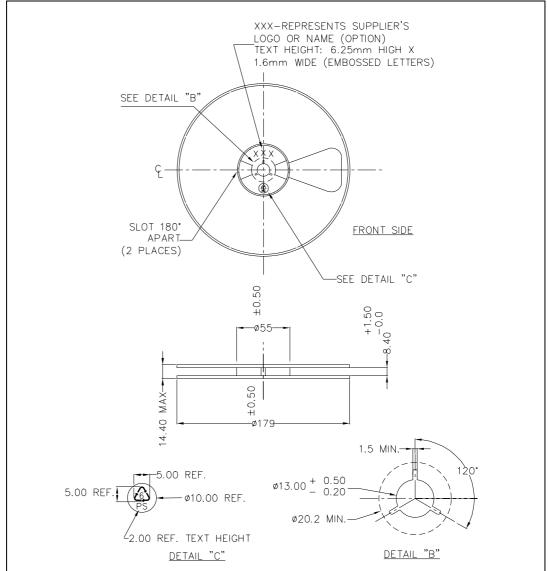


Figure 17. QFN10L (1.8 x 1.4 mm) reel information - front side



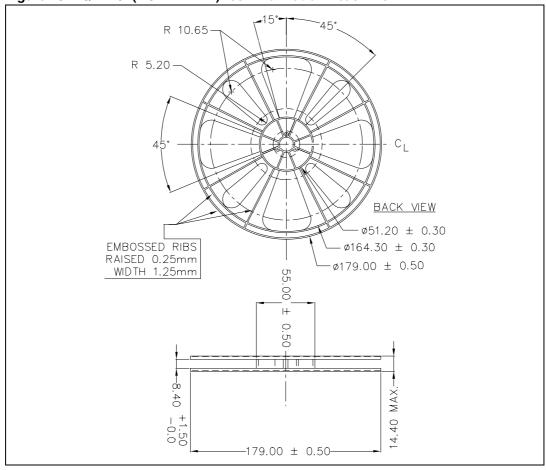


Figure 18. QFN10L(1.8 x 1.4 mm) reel information - back view





8 Revision history

Table 9.Document revision history

Date	Revision	Changes
9-Jan-2008	1	Initial release.



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